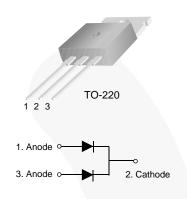


July 2014

MBR20150CT Dual High Voltage Schottky Rectifier

Features

- · Low Forward Voltage Drop
- · Low Power Loss and High Efficiency
- · High Surge Capability
- RoHS Compliant
- · Matte Tin (Sn) Lead Finish
- Terminal Leads Surface is Corrosion Resistant and able to Withstand to 260°C
- Wave Soldering or per MIL-STD-750 Method 2026.
- · Dual common Cathode



Ordering Information

Part Number	Top Mark	Package	Packing Method	
MBR20150CTTU	MBR20150CT	TO-220 3L	Rail	

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

Symbol	Parameter		Value	Unit	
V _{RRM}	Maximum Repetitive Reverse Voltage		150	V	
V _R	Maximum DC Reverse Voltage		150	V	
I _{F(AV)}	Average Rectified Forward Current, at T _C = 120°C	per Leg	10	Α	
		per Device	20	A	
I _{FSM}	Peak Forward Surge Current, 8.3 ms Half-Sine Wave		150	Α	
T _{STG}	Storage Temperature Range		-50 to +150	°C	
TJ	Operating Junction Temperature		150	°C	

Thermal Characteristics(1)

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case per Leg	1.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient per Leg	62.5	°C/W

Note:

1. MIL standard 883-1012 and JESD51-10.

Electrical Characteristics(2)

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
I _R	Reverse Current	V _R = 150 V, T _C = 25°C		0.2	mA
		$V_R = 150 \text{ V}, T_C = 125^{\circ}\text{C}$		2.0	
V _F	Forward Voltage	$I_F = 10 \text{ A}, T_C = 25^{\circ}\text{C}$		0.85	V
		I _F = 10 A, T _C = 125°C		0.75	
		$I_F = 20 \text{ A}, T_C = 25^{\circ}\text{C}$		0.95	
		$I_F = 20 \text{ A}, T_C = 125^{\circ}\text{C}$		0.85	

Note:

2. DC Item are tested by pulse test: pulse width $\leq 300~\mu s,$ duty cycle $\leq 2\%.$

Typical Performance Characteristics

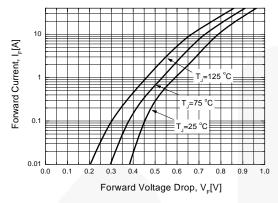


Figure 1. Forward Current Characteristics

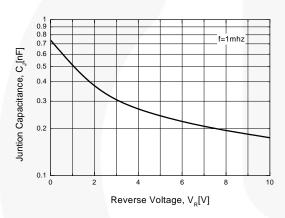


Figure 3. Junction Capacitance

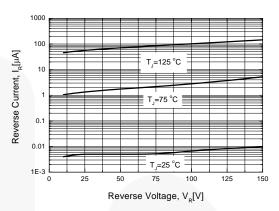


Figure 2. Reverse Leakage Current

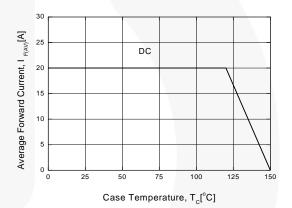


Figure 4. Power Derating

Physical Dimensions SUPPLIER "B" PACKAGE Ø4.00 3.50 10.67 SUPPLIER "A" PACKAGE SHAPE 3.40 2.50 IF PRESENT, SEE NOTE 'D' A 16.51 15.42 8.13 [2.46] С 14.04 12.70 FRONT VIEWS .62 42 ── "A1" SEE NOTE "F" OPTIONAL CHAMFER A 14.30 11.50 NOTE "I" BOTTOM VIEW NOTES: A) REFERENCE JEDEC, TO-220, VARIATION AB B) ALL DIMENSIONS ARE IN MILLIMETERS. DIMENSIONS ARE IN MILLIME IERS. DIMENSIONS COMMON TO ALL PACKAGE SUPPLIERS EXCEPT WHERE NOTED []. LOCATION OF MOLDED FEATURE MAY VARY (LOWER LEFT CORNER, LOWER CENTER) 2 AND CENTER OF THE PACKAGE) DOES NOT COMPLY JEDEC STANDARD VALUE. "A1" DIMENSIONS AS BELOW: SINGLE GAUGE = 0.51 - 0.61 DUAL GAUGE = 1.10 - 1.45 DRAWING FILE NAME: TO220B03REV8 PRESENCE IS SUPPLIER DEPENDENT SUPPLIER DEPENDENT MOLD LOCKING HOLES IN HEATSINK J) FAIRCHILD SEMICONDUCTOR **BACK VIEW** SIDE VIEW

Figure 5. TO-220, MOLDED, 3LEAD, JEDEC VARIATION AB

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/dwg/TO/TO220B03.pdf.

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: http://www.fairchildsemi.com/packing_dwg/PKG-TO220B03.pdf.





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

 AccuPower™
 F-PFS™

 Awinda®
 FRFET®

 AX-CAP®∗
 Global Power Resource

 BitSiC™
 GreenBridge™

 Build it Now™
 Green FPS™

 CorePLUS™
 Green FPS™ e-Series™

DEUXPEED® Making Small Speakers Sound Louder

MicroPak™

MicroPak2™

MillerDrive™

MotionMax™

MotionGrid®

 Dual Cool™
 and Better™

 EcoSPARK®
 MegaBuck™

 EfficientMax™
 MICROCOUPLER™

 ESBC™
 MicroFET™

Fairchild®
Fairchild Semiconductor®
FACT Quiet Series™
FACT®
FAST®
FastvCore™

FAST® MTi®
FastvCore™ MTx®
FETBench™ MVN®
FETBench™ mWSaver®
FPS™ OptoHiT™

OptoHiT™

PowerTrench[®] PowerXS™

Programmable Active Droop™

QFET[®]
QS[™]
Quiet Series[™]
RapidConfigure[™]

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™ SPM®

STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8

SupreMOS[®]
SyncFET™
Sync-Lock™

TinyLogic®
TINYOPTO™
TinyPower™
TinyPWM™
TranSiC™
TriFault Detect™
TRUECURRENT®*

µSerDes™

UHC®
Ultra FRFET™
UniFET™

TinyBoost[®]

TinyCalc™

TinyBuck[®]

UniFET™ VCX™ VisualMax™ VoltagePlus™ XS™ Xsens™ 仙童™

DISCLAIMER

■(R)

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are
 intended for surgical implant into the body or (b) support or sustain
 life, and (c) whose failure to perform when properly used in
 accordance with instructions for use provided in the labeling, can be
 reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Definition of Terms			
Datasheet Identification	Product Status	Definition	
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.	
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.	
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.	
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.	

Rev. 169

^{*} Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

AMEYA360 Components Supply Platform

Authorized Distribution Brand:

























Website:

Welcome to visit www.ameya360.com

Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com